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U.S. PRO
69258 02/26/97

A
Express Mail No: EM020164105US

Date: April 29, 1997

Attorney
Docket No.: CSDL1-490XX

65912 U.S. PTO
08/841224

69258 801 PATENT APPLICATION

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the **patent application** of:

Inventor: Marc S. Weinberg, Steven T. Cho, Ralph E. Hopkins III, Lance C. Niles, Anthony S. Kourepenis, Eric M. Hildebrant and Paul A. Ward

Entitled: TRENCHES TO REDUCE CHARGING EFFECTS AND TO CONTROL OUT-OF-PLANE SENSITIVITIES IN TUNING FORK GYROSCOPES AND OTHER SENSORS

Enclosed are:

- 3 sheets of informal drawings (one set)
- an Assignment of the invention to: _____
- a Certified copy of a _____ application
- a Verified statement re small entity status (§1.9 and §1.27)
- Information Disclosure Statement
- Continuation-in-part application of Application No. _____, filed _____.
- Priority under 35 USC §119(e) is claimed of the following provisional application(s).
 _____ (Application Number) (Filing Date)
 _____ (Application Number) (Filing Date)
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 _____ (Application Number) (Filing Date)

- The above-identified provisional application(s) is/are assigned of record to: _____
- The claim to small entity status in the above-identified provisional application(s) is made in this application and a copy of the Small Entity form(s) from the provisional application(s) is/are enclosed.

TRANSMITTAL FORM FOR FILING PATENT APPLICATION (CONTINUED)

Attorney
Docket No.: CSDL1-490XX

[] _____ is hereby appointed Associate Attorney by:
Registration No.:

Attorney of Record:
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[X] Other: Delaration and Power of Attorney signed by Steven T. Cho.

CLAIMS FILED:	MINUS BASE:	EXTRA CLAIMS:	RATE:	BASIC FEE:
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Independent	3 - 3	=	x \$80.00 =	0.00
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Attorney of Record: Charles L. Gagnebin, III
Registration No.: 25,467

SUBMIT IN TRIPPLICATE
101050



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application : Marc S. Weinberg, et al.
Filed : Herewith
For : TRENCHES TO REDUCE CHARGING EFFECTS AND
TO CONTROL OUT-OF-PLANE SENSITIVITIES IN
TUNING FORK GYROSCOPES AND OTHER SENSORS
Attorney's Docket : CSDL1-490XX
*
Express Mail Mailing Number: EM020164105US
Date of Deposit - April 29, 1997

I hereby certify that the following items are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and as addressed to BOX PATENT APPLICATION, Assistant Commissioner for Patents, Washington, D.C. 20231:

U.S. Patent application of Marc S. Weinberg, Steven T. Cho, Ralph E. Hopkins III, Lance C. Niles, Anthony S. Kourepinis, Eric M. Hildebrant and Paul A. Ward entitled: TRENCHES TO REDUCE CHARGING EFFECTS AND TO CONTROL OUT-OF-PLANE SENSITIVITIES IN TUNING FORK GYROSCOPES AND OTHER SENSORS, which claims benefit under Title 35, U.S.C. §119(e) consisting of

Specification includes:

PP, 1 through 10 of Abstract through Detailed Description; PP 11 through 14 of claims 1-20 together with a Declaration and Power of Attorney (signed) by Steven T. Cho, and unsigned by Marc S. Weinberg, Ralph E. Hopkins III, Lance C. Niles, Anthony S. Kourepinis, Eric M. Hildebrant and Paul A. Ward thereof, and a cover letter in triplicate.

Drawings as follows (one copy informal): 1st sheet of Fig. 1 & 2; 2nd sheet of Fig. 3; and a 3rd sheet of Fig. 4.

The above items are deposited with signatures and dated by the filing attorney as appropriate.

Stephen Arnold

CLG/HWA/89003

* * * * *

TRENCHES TO REDUCE CHARGING EFFECTS AND TO CONTROL
OUT-OF-PLANE SENSITIVITIES IN TUNING FORK
GYROSCOPES AND OTHER SENSORS

ABSTRACT

Trenches which reduce or eliminate force and sensitivity associated with proof mass motion normal to the substrate as a result of voltage transients is disclosed. The trenches provide increased separation between interleaved comb electrodes and the substrate, and thereby also reduce the comb lift to drive ratio. The trenches are typically formed directly below the interleaved comb electrodes, but may also be formed below other suspended portions. Trench depth is from 6-10 microns and provides a comb electrode to substrate separation of approximately 8.5-12.5 microns.

FIELD OF THE INVENTION

The present invention is related to micromechanical tuning fork gyroscopes, and more particularly to interleaved comb electrodes in micromechanical tuning fork gyroscopes.

BACKGROUND OF THE INVENTION

The basic theories of operation and construction of tuning fork gyroscopes are now fairly well known. Such gyroscopes include a substrate, silicon proof masses with comb electrodes, position sensitive pick-offs, sense electrodes, and inner and outer drives with comb electrodes. The proof masses are suspended above the substrate by a support flexure which permits movement of the proof masses relative to the sense electrode, the drive electrodes and the substrate.

The substrate, which is commonly constructed from glass, has a high electrical resistivity which is partially responsible for voltage transients which can adversely effect gyroscope performance. For example, coupling between comb electrodes is sensitive to such voltage transients. Additionally, the transients impart pick-off sensitivity and undesirable vertical (Z-axis) forces normal to the proof masses. This vertical force and pick-off sensitivity can (a) degrade tuning fork gyroscope performance and (b) prevent the tuning fork gyroscope motor self-oscillator loop from starting.

SUMMARY OF THE INVENTION

In accordance with the present invention, undesirable substrate voltage transient effects are alleviated by increasing the distance between the interleaved comb electrodes and the substrate surface. In a tuning fork gyroscope having drives with interleaved comb electrodes associated therewith, the distance is increased by forming trenches in the substrate below the interleaved comb electrodes. The trenches reduce the comb lift to drive ratio.

Trenches improve drive performance in two areas. First, when a glass substrate is used in a dissolved wafer process, charges accumulate on the surface of the glass as already described. Associated voltages then interact with the proof masses above the exposed glass to adversely effect starting and stability across temperature. When DC excitation of the sense electrodes is used, the charge induced by the voltage transients effectively alters the magnitude of voltage sensed by the motor sense electrodes. The trenches reduce the effects of the transient induced charge by effectively increasing the gap between the comb electrodes and the substrate surface. Second, the interleaved comb electrodes are intended to exert force parallel to the substrate surface. However, a dielectric or conducting substrate result in undesirable electrostatic Z-axis forces which are perpendicular to the substrate surface, and bias stability can thereby be adversely effected. When charging effects are reduced by using a conducting

substrate such as silicon, electrostatic lift force from the silicon can be larger than the drive force; a situation where self drive oscillator performance becomes impractical. The trenches reduce the Z-axis lift forces by effectively increasing the gap between the interleaved comb electrodes and the surface of the substrate.

Trenches also offer improved drive performance at a relatively modest cost. It has been found through experimentation that the undesirable effects of substrate voltage transients can be reduced by 50 to 65% in a gyroscope with a comb electrode to substrate surface gap of 2.5 microns by forming trenches with a depth of approximately 6 microns, i.e., increasing the gap in the trench area to 8.5 microns. Advantageously, this improved performance can be achieved without additional electronics using known wafer dissolving processes which are particularly cost efficient.

BRIEF DESCRIPTION OF THE DRAWING

These and other features and advantages of the present invention will be more fully understood from the following detailed description of the invention in which:

Fig. 1 is a plan view of a tuning fork gyroscope in accordance with the present invention;

Fig. 2 is a cross sectional view of the gyroscope of Fig. 1 taken along line 1-1;

Fig. 3 is a plan view of a subsection of the interleaved comb electrodes of Figs. 1 & 2; and

Fig. 4 is a plan view of an alternative embodiment of the tuning fork gyroscope of Fig. 1.

DETAILED DESCRIPTION OF THE DRAWING

Fig. 1 illustrates a tuning fork gyroscope in accordance with the present invention. The tuning fork gyroscope includes outer drives 3a, 3b with comb electrodes 5a, 5b, an inner drive 7 with comb electrodes 9a, 9b, proof masses 11a, 11b with comb electrodes 13a, 13b, 13c, 13d, trenches 15a, 15b, 15c, 15d, a substrate 17 with an upper surface 19, and a support flexure 21 with drive beams 23, torsion beams 25, base beams 27 and anchors 29. The proof masses are suspended above the substrate, and are connected thereto by the support flexure. The anchors connect the torsion beams to the substrate. The torsion beams support the base beams, which in turn support the drive beams. The proof masses are connected to the base beams by the drive beams.

The tuning fork gyroscope functions electromechanically. In operation, the inner and outer drives 7, 3a, 3b impart a vibratory motion to the proof masses 11a, 11b through the comb electrodes. The comb electrodes 5a, 5b of the outer drives extend outward toward the respective adjacent proof masses 11a, 11b, and are disposed above the surface of the substrate. The comb electrodes of the adjacent proof masses 11a, 11b extend outwardly towards the respective outer drives 3a, 3b such that respective outer drive comb electrodes 5a, 5b and proof mass comb electrodes 13a, 13d are

interleaved. Comb electrodes 9a, 9b, 13b, 13c between adjacent proof masses and the inner drive are similarly interleaved. As such, time varying drive signals V_d can be provided to the inner and outer drives to induce electrostatic coupling of the drive and proof mass comb electrodes and thereby impart vibratory motion to the proof masses.

Measurement with the tuning fork gyroscope has been described with detail in copending U.S. Patent Application 08/219,023, entitled ELECTRONICS FOR CORIOLIS FORCE AND OTHER SENSORS, filed in the name of Paul Ward, which is incorporated herein by reference. Briefly, a DC voltage $+V_s$, $-V_s$ is applied to sense electrodes 31 to establish a potential difference so that a change in capacitance between the sense electrodes and the adjacent proof masses results in a change in charge on the proof masses. At resonance, proof mass displacement lags drive force by ninety-degrees. In response to an inertial input, and specifically to a rotational rate about an input axis coplanar to the plane of vibration, the proof masses deflect out of the plane of vibration. Such out-of-plane deflection of the proof masses occurs at a frequency corresponding to the resonant frequency of the proof masses and with an amplitude corresponding to the input rotational rate. Thus, detection of out-of-plane deflection of the proof masses provides a measure of the rotational rate.

Voltages applied to the comb electrodes 12a, 12b, 14a, 14b and to the sense electrodes 36 induce both slow transient and AC voltages in the glass substrate, which is a dielectric with loss

factor and high, but finite, electrical resistivity. These voltages tend to degrade tuning fork gyroscope bias and scale factor versus time and temperature by injecting current into the proof masses and by applying forces to the proof masses. The trenches reduce the induced voltages and their effects on the proof mass, and hence on gyroscope performance.

The combs are desired to drive or sense motion parallel to the substrate. With conducting or resistive substrates below the combs, the combs affect vertical motion. With conducting substrates, charge transients are not an issue but starting and degraded performance are significant issues. With non-conducting substrates, charge transients, starting and degraded performance are all significant issues. High lift to drive ratio can degrade performance and even prevent the tuning fork gyroscope from starting. Lift to drive ratio is higher in conducting substrates than in dielectric materials. The trenches reduce the comb's lift to drive ratio, a technique which may be applied to both gyroscopes built on nonconducting and conducting (e.g., silicon) to allow larger drive amplitudes.

Turning now to both Fig. 1 and Fig. 2, trenches provide an increased distance between the silicon parts and the substrate, and thereby reduce or eliminate the normal force and sensitivity. A gap 41 is defined between inner and outer interleaved comb electrodes 43, 45 and the surface 19 of the substrate. The undesirable effects of substrate voltage transients on electrostatic coupling of the comb electrodes is at least in part

a function of the magnitude of this gap 41. Thus, in order to reduce the effects of such voltage transients, the gap is increased by forming trenches 15a, 15b, 15c, 15d in the substrate below the interleaved comb electrodes 43, 45. The trenches are disposed on the substrate substantially directly below the interleaved comb electrodes. More particularly, the interleaved comb electrodes have a length 33, and the trenches extend along the substrate for a length 35 which is equal to or greater than the interleaved comb electrode length as shown in Fig. 1.

Further placement details for the trenches are illustrated in Fig. 3. The interleaved comb electrodes 43, 45 have three regions which define width of overlap: region A is an unengaged drive comb electrode region, region B is an engaged comb electrode region, and region C is an unengaged proof mass comb electrode region. Magnitude of region B is directly related to maximum drive amplitude, i.e., greater width affords greater maximum drive amplitude. It should be appreciated, however, that regions A-C vary as the proof mass is vibrated, and this variation is taken into account when determining trench placement. In particular, the trenches are disposed between the substrate and the comb electrodes such that the trenches have a width 47 greater than or equal to a maximum operational width of region B. The term "overlap region" as used herein refers, therefore, to the maximum operational width of region B. Further, the trenches are disposed on the substrate substantially directly below the overlap region.

Turning again to Figs. 1 & 2, the trenches have a box-like shape with substantially flat walls 37 which are parallel to the Z-axis. The trenches have a width 47 which is substantially greater than or equal to the overlap region. It will be appreciated, however, that the shape and dimensions of the trenches may be varied without loss of the advantages of the present invention provided separation of the interleaved comb electrodes and the surface of the substrate is increased.

Trench excavation in crystal silicon or glass can be done by well known techniques such as isotropic etching. In the embodiment described above, the trenches have a depth 39 of approximately $6\mu\text{m}$ and the gap between the interleaved comb electrodes and the substrate surface in the trenches is approximately $8.5\mu\text{m}$. This arrangement has been found to reduce the undesirable effects due to substrate voltage transients by as much as 50-65%. However, it has also been found that trench depth can be increased to $10\mu\text{m}$ or more in order to further alleviate and even eliminate the effects of substrate charging. The trenches can also be combined with other techniques for additional performance enhancement and flexibility in reconciling performance and cost.

Although the tuning fork gyroscope has been thus far described and illustrated with trenches below each set of interleaved comb electrodes, alternate embodiments are possible and may present a superior solution for some applications. For example, to create a tuning fork gyroscope with variation of 300+ degrees per hour it is sufficient to place trenches below the inner interleaved comb

electrodes 43 alone, rather than below both the inner and outer interleaved comb electrodes 43, 45.

Fig. 4 is a plan view of an alternative embodiment of the tuning fork gyroscope of Fig. 1. In this embodiment trenches are formed in the substrate below the support flexure. In particular, first, second and third sets of trenches 51, 53, 55 are formed below the drive beams, torsion beams and base beams, respectively. These additional trenches further alleviate the undesirable effects of substrate voltage transients by providing increased separation between vibrating structures (proof masses, comb electrodes and support flexure) and the substrate.

It should be understood the invention is not limited to the particular embodiments shown and described herein, but that various changes and modifications may be made without departing from the spirit and scope of this novel concept as defined by the following claims.

CLAIMS

What is claimed is:

1 1. A drive for imparting a vibratory force to a vibrating member
2 with a driving member, the vibrating member suspended above a
3 surface of a substrate by a support flexure, comprising:

4 first comb electrodes connected to the driving member;

5 second comb electrodes connected to the vibrating member, said
6 second comb electrodes interleaved with said first comb electrodes,
7 an overlap region defined thereby, a gap being defined between the
8 substrate surface and the interleaved comb electrodes; and

9 a trench formed in the substrate substantially between the
10 interleaved comb electrodes and the substrate such that the gap
11 between the substrate surface and the interleaved comb electrodes
12 is increased.

1 2. The drive of Claim 1 wherein said trench has a width dimension
2 which is greater than or equal to said overlap region.

1 3. The drive of Claim 2 wherein said trench has a depth dimension
2 which is from 6 μ m to 10 μ m, inclusive.

1 4. The drive of Claim 3 wherein said trench is formed by a
2 dissolved wafer process.

1 5. The drive of Claim 2 wherein said trench has a depth dimension
2 which is greater than 10 μ m.

1 6. The drive of Claim 5 wherein said trench is formed by a
2 technique selected from the group consisting of reactive ion
3 etching, chlorine etching, SF₆ etching and anisotropic etching.

1 7. A tuning fork gyroscope comprising:
2 a substrate with a surface;
3 an outer drive with comb electrodes;
4 an inner drive with comb electrodes;
5 proof masses with inner and outer comb electrodes, said proof
6 masses suspended above said substrate by support flexure, said
7 inner comb electrodes interleaved with said inner drive comb
8 electrodes and said outer comb electrodes interleaved with said
9 outer drive comb electrodes, an overlap region defined by said
10 interleaved comb electrodes, a gap being defined between the
11 substrate surface and the interleaved comb electrodes; and
12 trenches formed in said substrate substantially between said
13 inner interleaved comb electrodes and said substrate such that the
14 gap between said substrate surface and said inner interleaved comb
15 electrodes is increased.

1 8. The tuning fork gyroscope of Claim 7 wherein said trenches
2 have a width dimension which is greater than or equal to said
3 overlap region.

1 9. The tuning fork gyroscope of Claim 8 wherein said trenches
2 have a depth dimension which is from $6\mu\text{m}$ to $10\mu\text{m}$, inclusive.

1 10. The tuning fork gyroscope of Claim 8 wherein said trenches
2 have a depth dimension which is greater than $10\mu\text{m}$.

1 11. The tuning fork gyroscope of Claim 9 wherein said gap is
2 increased by said trenches from about $2.5\mu\text{m}$ to a gap from $8.5\mu\text{m}$ to
3 $12.5\mu\text{m}$, inclusive.

1 12. The tuning fork gyroscope of Claim 8 wherein trenches are also
2 formed in said substrate substantially between the outer
3 interleaved comb electrodes and the substrate.

1 13. The tuning fork gyroscope of Claim 12 wherein said trenches
2 have a depth dimension which is from $6\mu\text{m}$ to $10\mu\text{m}$, inclusive.

1 14. The tuning fork gyroscope of Claim 12 wherein said trenches
2 have a depth dimension which is greater than $10\mu\text{m}$.

1 15. The tuning fork gyroscope of Claim 13 wherein said gap is
2 increased by said trenches from about $2.5\mu\text{m}$ to a gap from $8.5\mu\text{m}$ to
3 $12.5\mu\text{m}$, inclusive.

1 16. The tuning fork gyroscope of Claim 7 wherein trenches are also
2 formed in said substrate substantially between the support flexure
3 and the substrate.

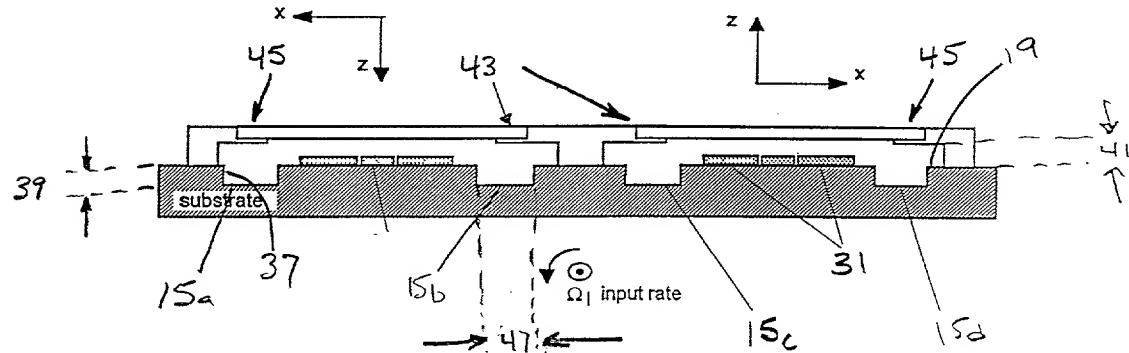
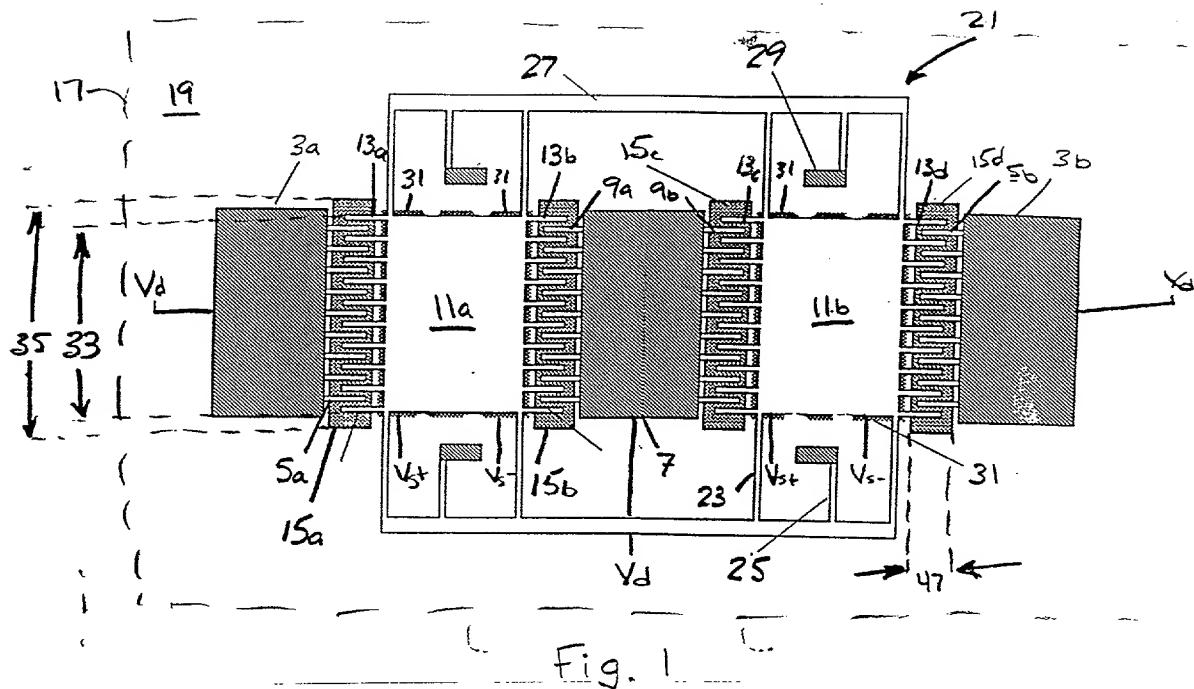
1 17. In a tuning fork gyroscope having interleaved comb electrodes
2 and a substrate surface with a gap defined therebetween, a method
3 for alleviating undesirable effects of substrate voltage transients
4 on gyroscope operation comprising the step of:

5 increasing the gap between the interleaved comb electrodes and
6 the substrate surface.

1 18. The method of Claim 17 wherein said increasing step includes
2 forming trenches below the interleaved comb electrodes.

1 19. The method of Claim 18 wherein the gyroscope includes a
2 support flexure and the method includes forming trenches below the
3 support flexure.

1 20. The method of Claim 18 wherein said forming step is
2 accomplished by a technique selected from the group consisting of
3 reactive ion etching, chlorine etching, SF₆ etching and anisotropic
4 etching.



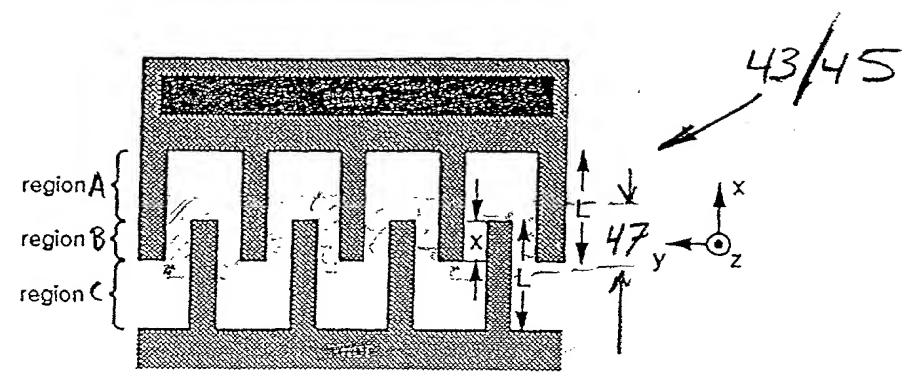


Fig. 3.

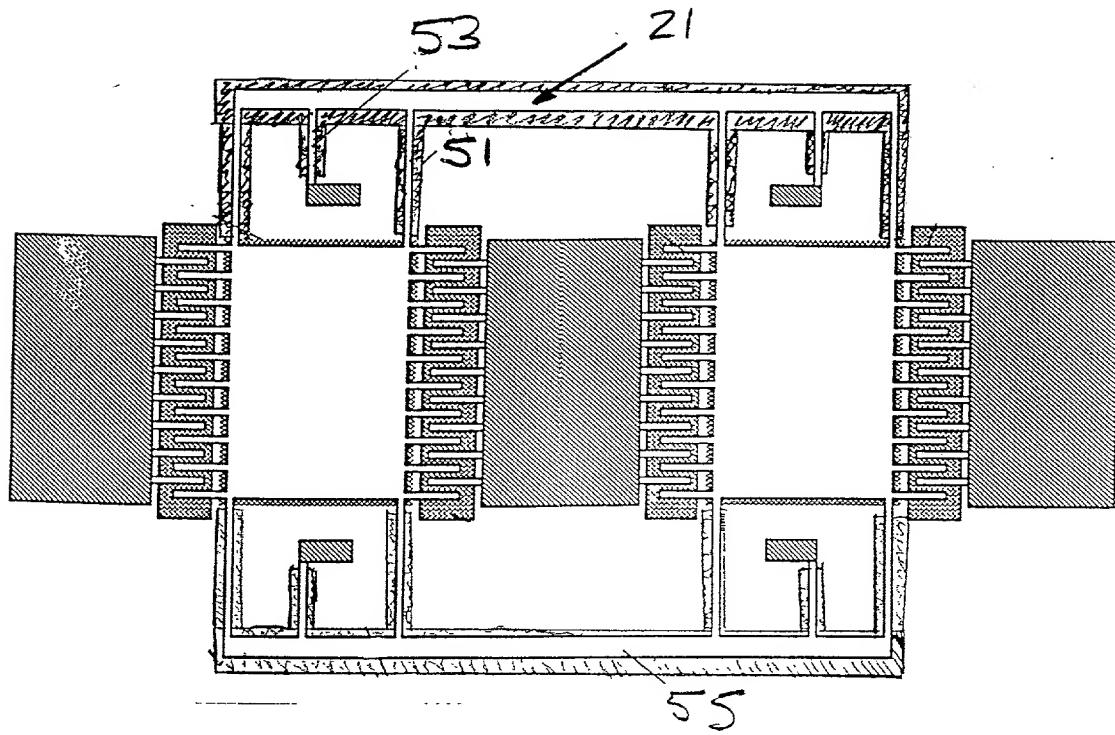


Fig. 4

Attorney
Docket No.: CSDL1-490XX

DECLARATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**TRENCHES TO REDUCE CHARGING EFFECTS AND TO CONTROL OUT-OF-PLANE
SENSITIVITIES IN TUNING FORK GYROSCOPES AND OTHER SENSORS**

the specification of which (check one):

is attached hereto. [] was filed _____ as Serial No. _____; amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations §1.56(a).

hereby claim foreign priority benefits under Title 35, USC §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>		<u>Date Filed</u>	<u>Priority Claimed</u>	
(Number)	(Country)	(Day/Month/Year)	[]	[]
(Number)	(Country)	(Day/Month/Year)	[]	[]
(Number)	(Country)	(Day/Month/Year)	[]	[]

I hereby claim the benefit under Title 35, USC §119(e) of any United States provisional application(s) listed below:

(Application Number)	(Filing Date)

Attorney
Docket No.: CSDL1-490XX

I hereby claim the benefit under Title 35 USC §120 of any United States application(s) listed below and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 USC §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Patented/pending/abandoned)
(Application Serial No.)	(Filing Date)	(Patented/pending/abandoned)
(Application Serial No.)	(Filing Date)	(Patented/pending/abandoned)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) to prosecute this application and transact all business connected therewith in the Patent and Trademark Office, and to file with the USRO any International Application based thereon.

Stanley M. Schurgin, Reg. No. 20,979
 Charles L. Gagnebin III, Reg. No. 25,467
 Paul J. Hayes, Reg. No. 28,307

Victor B. Lebovici, Reg. No. 30,864
 Eugene A. Feher, Reg. No. 33,171
 Beverly E. Hjorth, Reg. No. 32,033

Address all correspondence to:

WEINGARTEN, SCHURGIN, GAGNEBIN & HAYES
 Ten Post Office Square
 Boston, Massachusetts 02109
 Telephone: (617) 542-2290
 Telecopier: (617) 451-0313

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of First Inventor: Marc S. Weinberg		
City of Residence Needham	State or Country Massachusetts	Country of Citizenship U.S.A.
Post Office Address 119 Broad Meadows Road	City Needham	State or Country Zip Code Massachusetts 02192
Signature: (Please sign and date in permanent ink.) X		Date signed: X

Attorney
Docket No.: CSDL1-490XX

Full Name of Second Joint Inventor:

Steven T. Cho

City of Residence Santa Clara	State or Country California	Country of Citizenship U.S.A.
Post Office Address 1550 Vista Club Circle Apt #301	City Santa Clara	State or Country Zip Code California 95054
Signature: (Please sign and date in permanent ink.) X		Date signed: X

Full Name of Third Joint Inventor:

Ralph E. Hopkins III

City of Residence Brookline	State or Country Massachusetts	Country of Citizenship U.S.A.
Post Office Address 111 South Street	City Brookline	State or Country Zip Code Massachusetts 02167
Signature: (Please sign and date in permanent ink.) X		Date signed: X

Full Name of Fourth Joint Inventor:

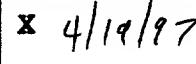
Lance C. Niles

City of Residence West Medford	State or Country Massachusetts	Country of Citizenship U.S.A.
Post Office Address 28 Kilgore Avenue Apt. #1	City West Medford	State or Country Zip Code Massachusetts 02155
Signature: (Please sign and date in permanent ink.) X		Date signed: X

Attorney
Docket No.: CSDL1-490XX

Full Name of Second Joint Inventor:

Steven T. Cho

City of Residence Santa Clara	State or Country California	Country of Citizenship U.S.A.
Post Office Address 1550 Vista Club Circle Apt #301	City Santa Clara	State or Country Zip Code California 95054
Signature: (Please sign and date in permanent ink.) 		Date signed: 

Full Name of Third Joint Inventor:

Ralph E. Hopkins III

City of Residence Brookline	State or Country Massachusetts	Country of Citizenship U.S.A.
Post Office Address 111 South Street	City Brookline	State or Country Zip Code Massachusetts 02167
Signature: (Please sign and date in permanent ink.) 		Date signed: 

Full Name of Fourth Joint Inventor:

Lance C. Niles

City of Residence West Medford	State or Country Massachusetts	Country of Citizenship U.S.A.
Post Office Address 28 Kilgore Avenue Apt. #1	City West Medford	State or Country Zip Code Massachusetts 02155
Signature: (Please sign and date in permanent ink.) 		Date signed: 